

Schottky Barrier Diode DB2X41100L

DB2X41100L Silicon epitaxial planar type

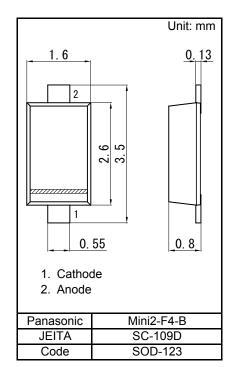
For rectification

DB2J411 in Mini2 type package

- Features
- · Low forward voltage and low reverse leakage current
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 4R

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

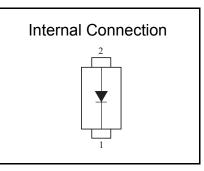


■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|--|--------|-------------|------|
| Reverse voltage | VR | 40 | V |
| Forward current (average) *1 | IF(AV) | 1 | А |
| Non-repetitive peak forward surge current *2 | IFSM | 7 | Α |
| Junction temperature ^{*1} | Tj | 150 | °C |
| Operating ambient temperature | Topr | -40 to +85 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |
| | | | |

Note: *1 TI = 80 °C

*2 50 Hz sine wave 1 cycle (Non-repetitive peak current)



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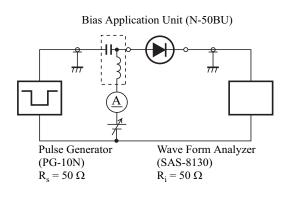
■ Electrical Characteristics Ta = 25 °C ± 3 °C

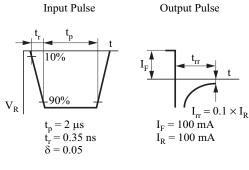
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|-------------------------------------|--------|----------------------------------|-----|------|------|------|
| Forward voltage | VF | IF = 1 A | | 0.50 | 0.58 | V |
| Reverse current | IR | VR = 40 V | | 15 | 100 | μA |
| Terminal capacitance | Ct | VR = 10 V, f = 1 MHz | | 21 | | pF |
| Reverse recovery time ^{*1} | trr | IF = IR = 100 mA, Irr = 0.1 × IR | | 6.8 | | ns |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. *1 trr test circuit

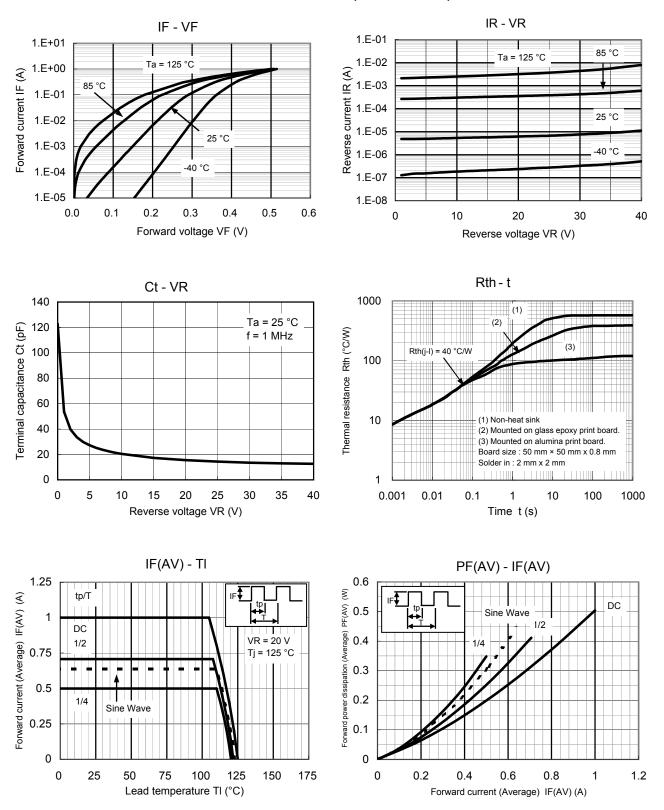




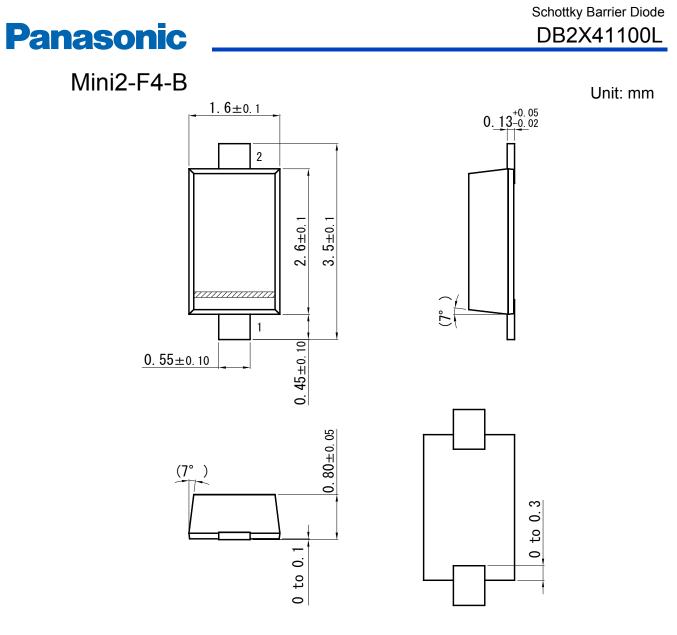
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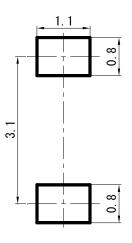
Technical Data (reference)



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Land Pattern (Reference) (Unit: mm)



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